



MPGDs for Fast Timing Applications (MPGD-FaTimA) The Big Picture

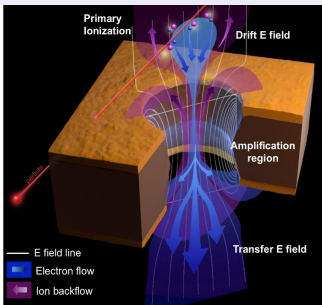
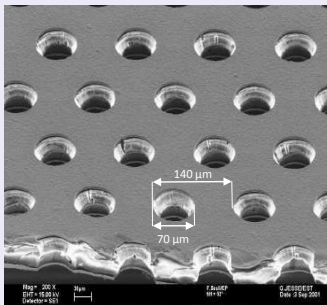
Piet Verwilligen

INFN sez. Bari

MPGD FaTimA meeting 2
December 21th 2017, Bari

Micro Pattern Gaseous Detector (MPGD)

Example: Gas Electron Multiplier (GEM)

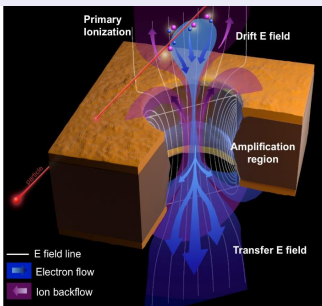
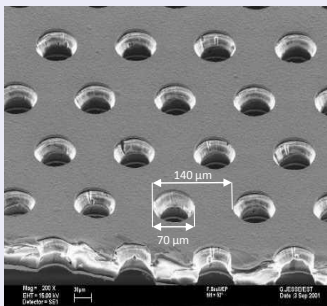


Advantages:

- Photo-lithographic techniques allowed to produce **Micro Patterned** detectors
- Main Characteristics: High rate capability ($> 50 \text{ MHz/cm}^2$), good spatial resolution ($50 \mu\text{m}$), high efficiency ($\geq 95 \%$), time resolution of $\mathcal{O}(5\text{--}10 \text{ ns})$
- flexible detector structures (cfr. cylindrical trackers for KLOE and BES-III)

Micro Pattern Gaseous Detector (MPGD)

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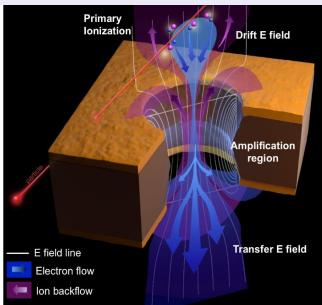
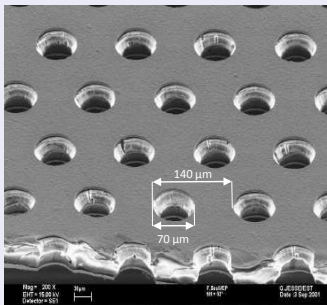


Advantages:

- Two separated regions: **drift region** (creation of electron-ion pairs) and **gain region** (multiply drifted electrons to observable electric signal)
- Rate capability is improved by fast collection of positive ions
- MPGD Time resolution driven by fluctuations in creation of electron-ion pairs

Micro Pattern Gaseous Detector (MPGD)

Example: Gas Electron Multiplier (GEM)

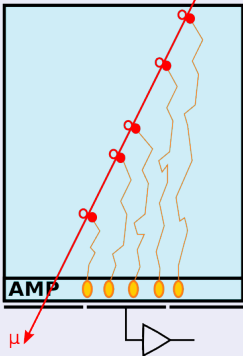


Drawbacks:

- Single Stage Gain limited to few 10^3 \Leftrightarrow Wire detectors: 10^4 – 10^5
- Recently μ -RWELL: Gains of few 10^4 with LHCb Triple-GEM Gas ($\text{Ar}:\text{CO}_2:\text{CF}_4$)
- Discharges Limits Maximum Gain and provoking irreversible damage

Fast Timing MPGD Principle

Traditional MPGD



σ_t driven by distance fluct's

$$\sigma_t \propto 1/(\lambda v_{\text{drift}})$$

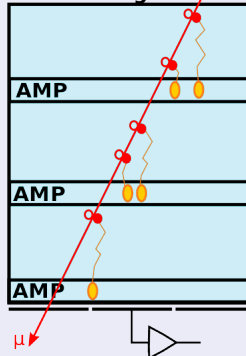
$$\lambda = \# \text{ primary cls}$$

electron-ion pairs created close to amplification structure result in fast signals

Fast Timing MPGD:
split drift volume in N layers, each with own amplification structure

$$\sigma_t \propto 1/(\lambda v_{\text{drift}} N)$$

Fast Timing MPGD

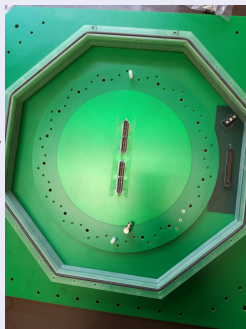
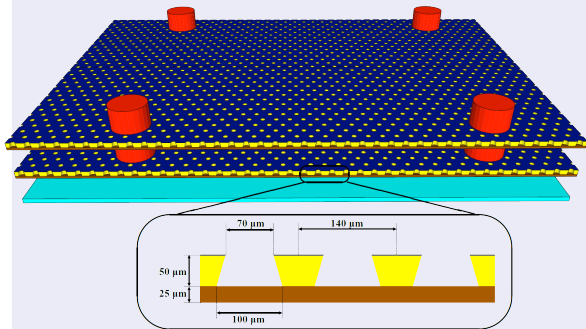


- resistive structure \Rightarrow signal from any layer induced in readout
- resistive structure \Rightarrow limits development of discharges
- time resolution should improve with $N = \text{number of layers}$

New FTM Prototype (FTM-v4) :: Design

4-layer prototype:

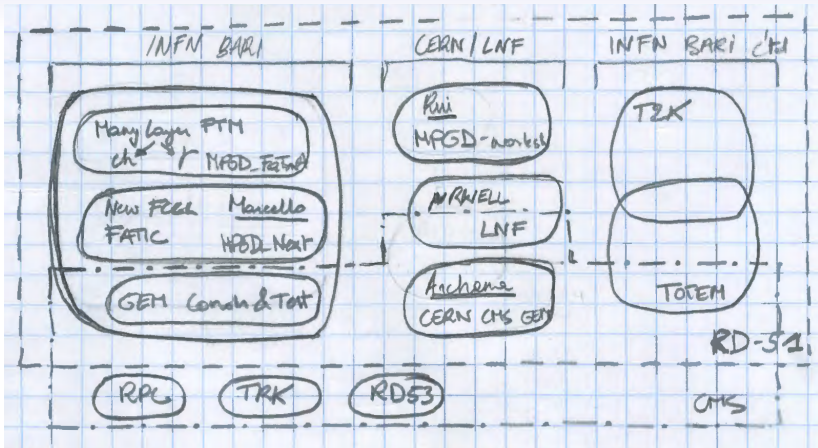
(extendible to 16 layers)



Single layer specifications:

- Drift layer: 250 μm drift layer (Red: Dupont Coverlay spacers)
- Gain layer: 50 μm kapton (Yellow: GEM foil: 70 μm hole, 140 μm pitch)
- Support Layer: 200 μm (Brown: Pre-Preg (glue) + FR4 PCB)
- Resistive coating: 10–100 nm, ~ 100 MΩ/□ (Blue: Diamond Like Carbon: DLC)

Research Environment: INFN Ba, LNF, CERN



- **“Competitor”**: Picosec (CERN/CEA Saclay/Greece): 100 ps
(but likely *not rad-hard*, cheap and difficult to go to *large area* due to γ -cathode)

FTM Funding in CSN-V

MPGD Next (2016-2018):

PI Silvia Dalla Torre

- groups INFN (Trieste, Roma, Bari, LNF) R&D on MPGDs: THGEM, Resistive MM, FTM, μ RWELL
- **New Structures:** (PI: *Marcello Maggi*): R&D of new FCCL (125 μ m, Cu-DLC-PI-DLC-Cu, ...), study elementary cell
- **Electronics:** (PI: *Antonio Ranieri*): R&D of Front-End Chip for Fast Timing MPGD
 - first submission to foundary (Dec 2016) funded by CSN-I

MPGD FaTimA (2016-2017):

PI Piet Verwilligen

- development of FTM for Fast Timing Applications (FaTimA)
 - demonstrate fast timing of multi-layer FTM for charged particles (HEP)
 - adapt multi-layer FTM for 511 keV photons (TOF-PET)

FTM Challenges

FTM requirements:

- detection of single photo- e^- (closest) instead of all e^- in drift
(i.e. factor 10 reduction in charge)
- detection with single amplification layer
(Triple GEM has amplification divided in three stages)

Therefore:

- ⇒ need high gain structure, with low spark/discharge rate
- ⇒ need low noise detector and low noise electronics
- ⇒ need electronics that can process pulse with low charge ($10^4 e^- = 1.6 \text{ fC}$)
- ⇒ need electronics that can process and preserve a fast pulse

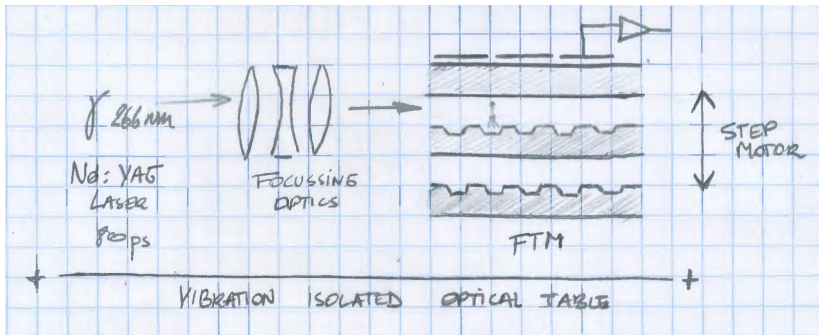
This Meeting:

- Discuss Future plans for Electronics (FATIC v2)

Expectations for 2018

- 1 HV-cleaning of FTM-v4:**
 - demonstrate we reach same (high) gains in single layer as μ -RWELL
 - use Ar:CO₂, Ar:CO₂:CF₄, Ar:iC₄H₁₀, Ne::iC₄H₁₀ mixtures
- 2 Test FTM with a Laser:**
 - first test: Antonio Ancona CNR (~ 335 nm)
 - later: purchase 800 ps UV (~ 265 nm) laser with μ J/pulse)
 - will be also the first test for FTM + electronics !!!
- 3 Develop Test Beam Setup and test FTM with Beams at CERN**
 - Arrival of 2 Mosaic Boards
 - Procurement of Tracking GEM and MCP for timing reference
- 4 Develop large area FTM-v5:** 30×30 cm² with spacer less design
 - Discussed with Rui to make test-setup to check kapton sag
- 5 Produce FTM with Lower Resistivity:** to study rate capability
(funded by CSN-I RD_FA)
- 6** in meanwhile keep simulating and bring also the γ -FTM to a next stage
 - will have a dedicated meeting in January
- 7 mid-2018: start writing proposal for ERC starting grant**

Laser Tests



Test Beam Setup

